

APM2306AC-TRL-VB Datasheet

N-Channel 30-V (D-S) MOSFET

PRODUC	CT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)
30	0.030 at V _{GS} = 10 V	6.5	4.5 nC
	0.033 at V _{GS} = 4.5 V	6.0	4.5110

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET

GC

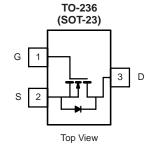
- 100 % Rg Tested
- Compliant to RoHS Directive 2002/95/EC

N-Channel MOSFET

APPLICATIONS

DC/DC Converter





ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Parameter Symbol Limit Unit Drain-Source Voltage 30 V_{DS} V V_{GS} Gate-Source Voltage ± 20 T_C = 25 °C 6.5^a T_C = 70 °C 6.0 Continuous Drain Current (T_J = 150 °C) I_D T_A = 25 °C 5.3 $T_A = 70 \degree C$ А 5.0 Pulsed Drain Current I_{DM} 25 T_C = 25 °C 1.4 Continuous Source-Drain Diode Current Is T_A = 25 °C 0.9^{b, c} $T_{\rm C} = 25 \,^{\circ}{\rm C}$ 1.7

Maximum Power Dissipation	T _C = 70 °C	PD	1.1	w
Maximum rower Dissipation	T _A = 25 °C	. 0	1.1 ^{b, c}	**
	T _A = 70 °C		0.7 ^{b, c}	
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperat	ure) ^{d, e}		260	
			·	

THERMAL RESISTANCE RA	TINGS				
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	90	115	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60	75	0/11

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 130 °C/W.

SPECIFICATIONS $T_J = 25 \ ^{\circ}C$,	unless othe	rwise noted				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				_		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		31		mV/°0
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 <u>0</u> – 200 µA		- 5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.7	1.1	2.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			1 10	μA
On-State Drain Current ^a		$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	10		10	A
On-State Drain Current.	I _{D(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.2 \text{ A}$	10	0.030		~
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2.8 \text{ A}$		-		Ω
	~	$V_{GS} = 4.3 \text{ V}, \text{ I}_{D} = 2.8 \text{ A}$ $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 4.8 \text{ A}$		0.033		
Forward Transconductance ^a	9 _{fs}	$V_{\rm DS} = 15$ V, $I_{\rm D} = 4.8$ A		11		S
Dynamic ^b	-			1	1	
Input Capacitance	C _{iss}			335		
Output Capacitance	C _{oss}	$V_{DS} = 15 V$, $V_{GS} = 0 V$, f = 1 MHz		45		pF
Reverse Transfer Capacitance	C _{rss}			17		
Total Gate Charge	Qg	V_{DS} = 15 V, V_{GS} = 10 V, I_{D} = 3.4 A		4.5 2.1	6.7 3.2	-
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 V, V_{CS} = 4.5 V, I_{D} = 3.4 A$		0.85	0.2	nC
Gate-Drain Charge	Q _{gd}			0.65		
Gate Resistance	R _g	f = 1 MHz	0.8	4.4	8.8	Ω
Turn-On Delay Time	t _{d(on)}		0.0	12	20	
Rise Time	t _r	V_{DD} = 15 V, R ₁ = 5.6 Ω		50	75	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 2.7 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		12	20	1
Fall Time	t _f			22	35	-
Turn-On Delay Time	t _{d(on)}			5	10	ns
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_1 = 5.6 \Omega$		12	20	-
Turn-Off Delay Time	t _{d(off)}	$V_{\text{DD}} = 10$ V, $N_{\text{L}} = 3.0$ M $I_{\text{D}} \cong 2.7$ A, $V_{\text{GEN}} = 10$ V, $R_{\text{g}} = 1$ Ω		10	15	-
Fall Time	t _f			5	10	-
Drain-Source Body Diode Characteristi				Ů	10	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			1.4	
Pulse Diode Forward Current	I _{SM}				1.4	A
Body Diode Voltage	V _{SD}	I _S = 2.7 A, V _{GS} = 0 V		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			10	20	ns
Body Diode Reverse Recovery Charge	Q _{rr}			5	10	nC
Reverse Recovery Fall Time	-	I_F = 2.7 A, dI/dt = 100 A/µs, T_J = 25 °C		6	10	
	t _a					ns
Reverse Recovery Rise Time	t _b			4		

Notes:

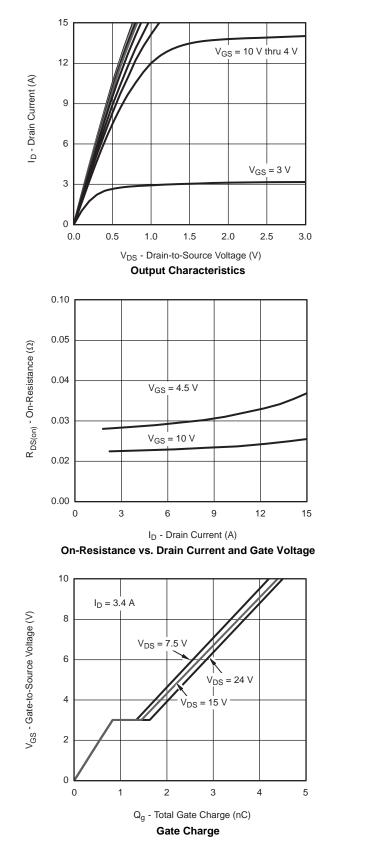
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

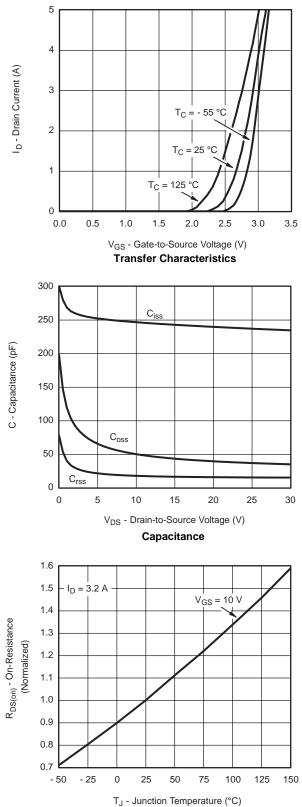
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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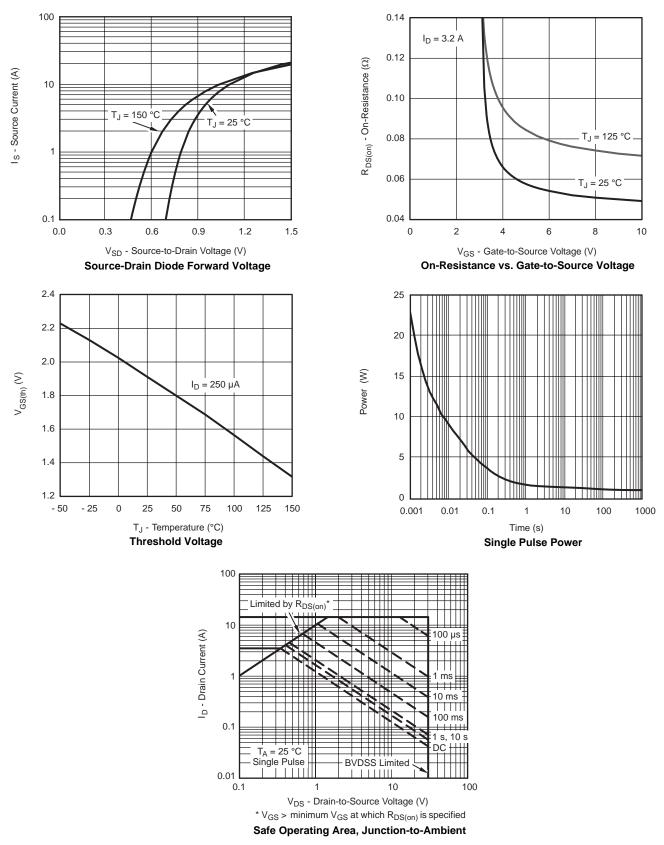




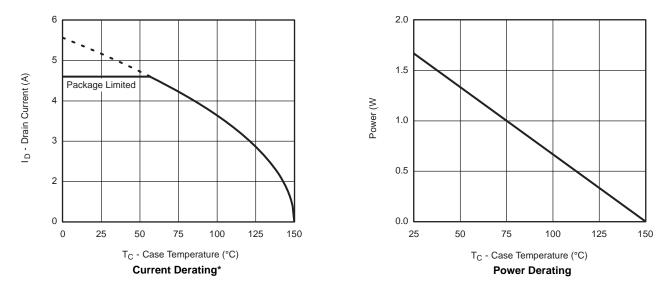


On-Resistance vs. Junction Temperature



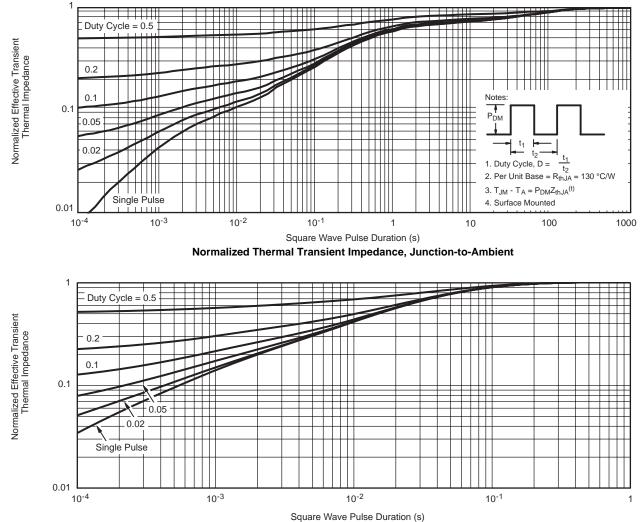






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





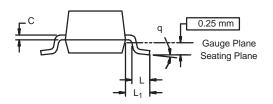
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD





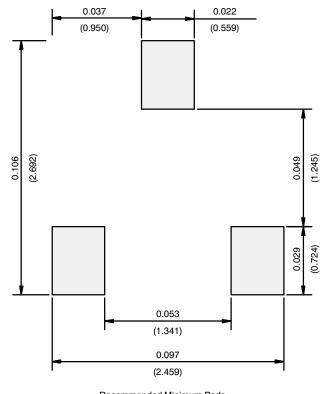


Max 1.12 0.10 1.02 0.50 0.18 3.04 2.64 1.40	Min 0.035 0.0004 0.0346 0.014 0.003 0.110 0.083	Max 0.044 0.004 0.040 0.020 0.007 0.120 0.104
0.10 1.02 0.50 0.18 3.04 2.64	0.0004 0.0346 0.014 0.003 0.110 0.083	0.004 0.040 0.020 0.007 0.120
1.02 0.50 0.18 3.04 2.64	0.0346 0.014 0.003 0.110 0.083	0.040 0.020 0.007 0.120
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0.18 3.04 2.64	0.003 0.110 0.083	0.007 0.120
3.04 2.64	0.110 0.083	0.120
2.64	0.083	
		0.104
1 40		
1.40	0.047	0.055
BSC	0.0374	1 Ref
BSC	0.0748	3 Ref
0.60	0.016	0.024
Ref	0.025	Ref
Ref	0.020	Ref
8°	3°	8°
	4 Ref D Ref 8°	0.020 Ref 0.020

APM2306AC-TRL-VB



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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